

# Deep UV LED Package

(SCM13AUC00F1Z1)

#### **Product introduction**

Sanan SCM13AU series deep ultraviolet packaging product is a kind of compact and large angle package. It's specially designed for lower radiation power application.

#### **Features & benefits**

- **ü** Deep UV LED with emission wavelength between 272 nm and 285 nm
- **Ü** Ultra-compact form factor: 1.3 mm x 1.3 mm x 0.85 mm package
- **ü** Wide viewing angle >120 deg
- **ü** High reliability package with ESD protection
- ü Standard SMD Process
- **ü** RoHS and REACH compliant

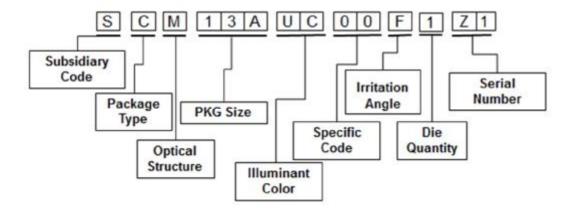
#### **Target Application**

- **ü** Water/ Air/ Surface sterilization and disinfection
- **ü** Food & Pharmaceutical Processing
- **ü** Medical Spectroscopy
- ü Florescence analyzer
- **ü** Horticulture lighting



#### **Part Number Nomenclature**

The part number of Sanan SCM13AU series deep UV package products is explained as follow:



#### **Ordering Information**

Part Number: SCM13AUC00F1Z1

Specification nomenclature: reference to Bin Kit Order Codes (wavelength and output

radiant power) (272ABC)

#### Optical and Electrical Characteristics@40mA

Parameter	Symbol	Bin	Minimum	Typical	Maximu m	Unit
Peak Wavelength	$\lambda_{ m P}$	272A	272		285	nm
Output Radiant Power	Popt	BC	2	-	4	mW
		BD	4		6	mW
		BE	6		8	mW
Forward Voltage	$\mathbf{V_F}$		4.5	6.5	7	V
FWHM	Δλ		-	9.6	-	nm
Viewing Angle	2θ <sub>1/2</sub>		-	150	-	0
Thermal Resistance (Tj - Tsp)	$\mathbf{R}_{th}$		-	20	-	°C/W

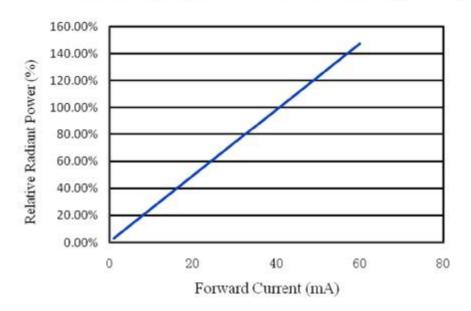


#### **Absolute Maximum Ratings**

Parameter	Symbol	Max. Ratings	Units
Forward Current	$I_{\mathrm{F}}$	60	mA
Reverse Voltage	$V_R$	-5	V
Operating Temperature	T <sub>op</sub>	-40 ~ 85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ 100	°C
Junction Temperature	T <sub>j</sub>	85	°C
Soldering temperature	T <sub>solder</sub>	260	°C

#### **Optical and Electrical Characteristics**Curve

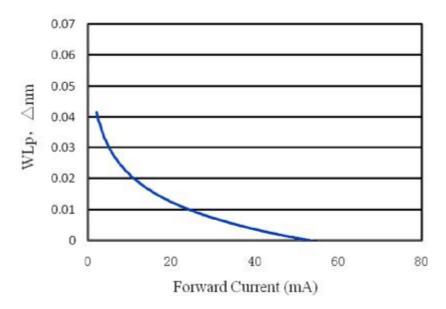
#### Relative Radiant Power VS Forward Current (Ta=25 °C)



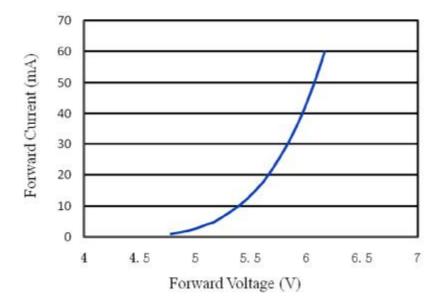


### Sanan Optoelectronics

#### Wavelength △ VS Forward Current (Ta=25 °C)



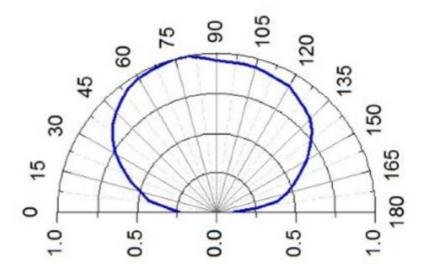
#### Forward Current VS Forward Voltage (Ta=25 °C)



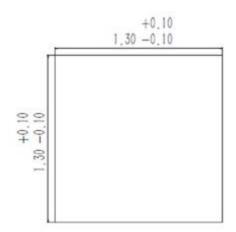


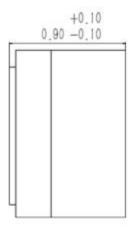
## Sanan Optoelectronics

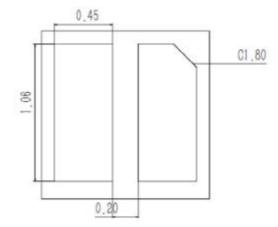
#### **Radiant Pattern**



#### **Mechanical Dimension (Unit: mm Tolerance +/-0.1):**

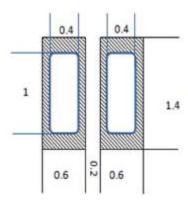








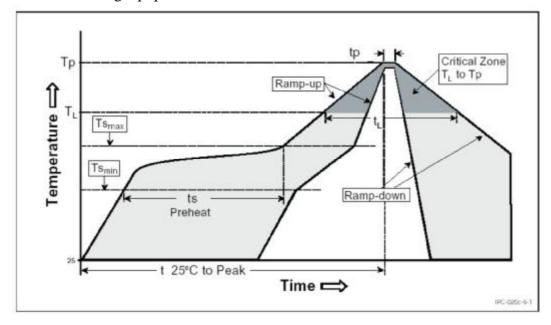
#### **Recommended Stencil Pattern (Unit: mm Tolerance +/- 0.1):**



Solder Pad	1.4mm x 0.6mm		
Stencil Pattern	1.0mm x 0.4mm		

#### **Recommended Reflow Profile**

As a general guideline, Sanan recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used. Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.





Profile Setting	Pb-Free Profile
Average Ramp-up Rate (Tsmax,Tp)	1°C/s
Preheat Temperature Min(Tsmin)	100-150 °C
Preheat Temperature Max(Tsmax)	180-200 °C
Preheat Time (ts min to tsmax)	60-120s
Liquidus Temperature(TL)	217 °C
Time Maintained Above Time(tL)	50-80 s
Peak/Classification Temperature(TP)	260 °C
Time within 5°C of Actual Peak Temp(tP)	20-40 s
Ramp-Down Rate	2-3 °C/s
Time25°CPeakTemperature	4 mins

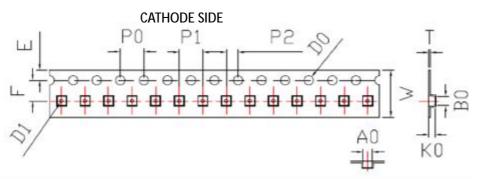
#### **Reliability Test**

Item	Conditions	Failure Criteria
Room Temperature Operating Life	25 °C, 20 mA, 1000Hrs	
High Temperature Storage	mperature Storage 100 °C, 1000Hrs	
Low Temperature Storage	-40 °C, 1000Hrs	
Temperature Cycles (100cycles)	-40 °C (30 mins) ~ +25 °C (5 mins) +100 °C (30 mins) ~ +25 °C (5 mins)	
ESD (Human Body mode)	$R = 1.5 \text{ K}\Omega$ , $C = 100 \text{ pF}$ ; Test Voltage = 8KV, 3 times negative/positive	$V_{\rm f} < 110\%$ $P_{\rm opt} > 70\%$
Moisture Sensitive Level(MSL)	3 time reflow, peak temperature +260 °C,10s Pre-conditioning: +30 °C, 60% RH for 192h	
Vibration Test	20 Hz-2000 Hz-20Hz, 200m/s2, 4cycles,4 min, each X,Y, Z	

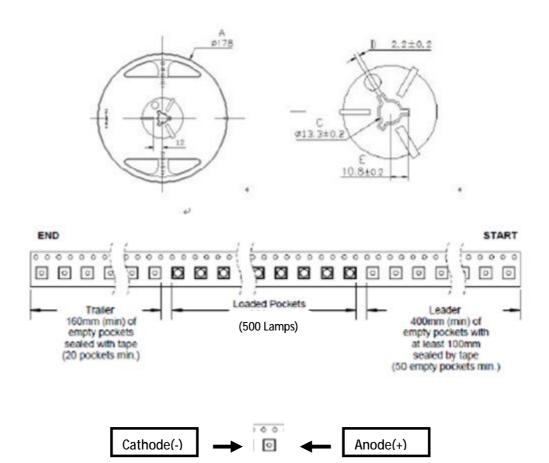


#### **Tape & Reel Packaging**

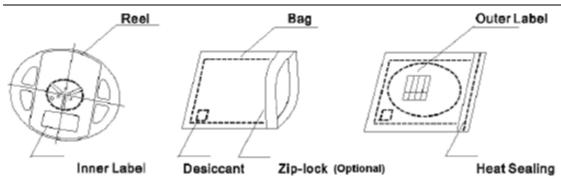
(Unit: mm)



Symbol	<b>A0</b>	В0	K0	P0	P1	P2
Spec	1.55±0.10	1.55±0.10	1.0±0.10	4.00±0.10	4.00±0.10	2.00±0.10
Symbol	W	T	E	F	<b>D</b> 0	D1
Spec	8.0±0.20	0.20±0.05	1.75±0.10	3.50±0.10	1.5+0.1/-0	0.6±0.1







#### Precautions for storage, handling and use of UV LED components

#### **UV** Light

These devices are short wavelength Ultraviolet LED. During operation, the LED emits high intensity ultraviolet (UV) light, which is harmful to skin and eyes.

UV light is hazardous to skin and may cause cancer. Avoid exposure to UV light when LED is operational.

Precautions must be taken to avoid looking directly at the UV light without the use of UV light protective glasses. Do not look directly at the front or at the LED's lens when LED is operational.

#### **Static Electricity (ESD)**

Despite with built-in Zener protection diodes, UV LED are particularly sensitive to ESD (Electrostatic Discharge); static electricity and surge voltages seriously damage UV LEDs and can result in complete failure of the device. Precautions must be taken against ESD when handling or operating these devices.

#### **Operating Conditions**

In order to ensure the correct functioning of these LEDs, compliance to the typical electrical specifications is paramount. UV LEDs are particularly sensitive to any current value that exceed the max operating specifications, and will cause damage and possible complete failure to the device. The use of current regulated drive circuits are strongly recommended when operating these devices These LEDs are susceptible to heat generation. Provide adequate thermal management to ensure LEDs do not exceed maximum recommended temperatures. Operating LEDs at temperatures in excess of specification will result in damage and possible complete failure of the device.

The following warning labels are attached to the product/system using ultraviolet.





#### Label information

### Sanan Optoelectronics

PN:SCM13AUC00F1Z1

Bin Cd:275ABD

Lot Cd:UN19060500001

QTY:50

WIP ID:US201906140001

